



Fw = 100kHz/phase

Rev	Number	Reason
1	000001	Initial Release
2	000002	Design Change
3	000003	Design Change
4	000004	Design Change
5	000005	Design Change
6	000006	Design Change
7	000007	Design Change
8	000008	Design Change
9	000009	Design Change
10	000010	Design Change

1 2 3 4 5 6

H1
NY PMS 440 0025 PH

H2
NY PMS 440 0025 PH

PCB Number: PRJ_Number
PCB Rev: PCB_Rev

H3
NY PMS 440 0025 PH

H4
NY PMS 440 0025 PH

FID1 FID2 FID3 FID4 FID5 FID6

PCB
LOGO
Texas Instruments

PCB
LOGO
ESD Susceptible

1 2 3 4 5 6

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Designed for: Texas Instruments Corp	Mod Date: 6/4/2013
Project: PMP7967 REVA	
Sheet Title: ChangeMe	Sheet: 2 of 2
Size: B	Schematic: 870PMP7967 Rev: A
Assembly Variant: [No Variations]	
File: Hardware_ANSI-B_SchDoc	
Contact: http://www.national.com/support	



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A

A

B

B

C

C

D

D

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